查询AP504供应商



The Communications Edge TM

Product Information

Product Features

- 1705 1790 MHz
- 33 dB Gain
- +25 dBm CDMA2k 7fa Power
- +12 V Single Supply
- Power Down Mode
- Bias Current Adjustable
- RoHS-compliant flange-mount pkg

Applications

- Final stage amplifiers for Repeaters
- Optimized for driver amplifier PA mobile infrastructure

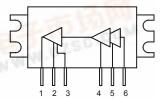
Product Description

The AP504 is a high dynamic range power amplifier in a RoHS-compliant flange-mount package. The multi-stage amplifier module has 33 dB gain. The module has been internally optimized for linearity to provide +25 dBm (-63 dBc ACPR) linear power for 7-carrier CDMA2000 applications.

The AP504 uses a high reliability InGaP/GaAs HBT process technology and does not require any external matching components. The module operates off of a +12V supply and does not requiring any negative biasing voltages; an internal active bias allows the amplifier to maintain high linearity over temperature. It has the added feature of a +5V power down control pin. While the module has been tuned for optimal performance for Class AB applications, the quiescent current can also be adjusted for Class B applications through an external resistor. A low-cost metal housing allows the device to have a low thermal resistance and achieves over 100 years MTTF. All devices are 100% RF and DC tested.

The AP504 is targeted for use as a driver or final stage amplifier in wireless infrastructure where high linearity and high power is required. This combination makes the device an excellent candidate for next generation multi-carrier 3G base stations using the DCS1800 frequency band.

Functional Diagram



Top View

Pin No.	Function
1	RF Output
2 / 4	Vcc
3 / 5	Vpd
6	RF Input
Case	Ground

Specifications (1)

 $2\bar{5}$ °C, V_{cc} =12V, V_{pd} =5V, I_{cq} =835mA, R7=0 Ω , 50 Ω unmatched fixture

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Parameter	Units	Min	Тур	Max	Test Conditions
Operational Bandwidth	MHz	1705 – 1790		00	
Test Frequency	MHz	15	1765		W.
Adjacent Channel Power Ratio	dBc	10 37	-63.2	-61	CDMA2000 7fa 25 dBm Total Power, 885 kHz offset
Power Gain	dB	30.5	33	35.5	Pout = +25 dBm
Input Return Loss	dB		11		
Output Return Loss	dB		5		
Output P1dB	dBm		+36		- 57
Output IP3	dBm		+52		Pout = +23 dBm/tone, $\Delta f = 1$ MHz
Operating Current (2)	mA	790	850	940	Pout = +25 dBm
Quiescent Current, Icq (2)	mA	780	835	920	DZSU.
Device Voltage, Vcc	V		+12		The Man Man As .
Device Voltage, Vpd	V		+5	6	Pull-down voltage: 0V = "OFF", 5V="ON"
Load Stability	VSWR	10:1	1871	100	(6)

^{1.} Test conditions unless otherwise noted: 25°C.

Absolute Maximum Rating

Parameter	Rating
Operating Case Temperature	-40 to +85 °C
Storage Temperature	-55 to +150 °C
Prinput Power (continuous) with output terminated in 50 Ω	+15 dBm
10 dt d=0 0 000	

Ordering Information

Part No.	Description
AP504	DCS-band 4W HBT Amplifier Module
AP504-PCB	Fully-Assembled Evaluation Board (Class AB configuration, Icq=835mA)

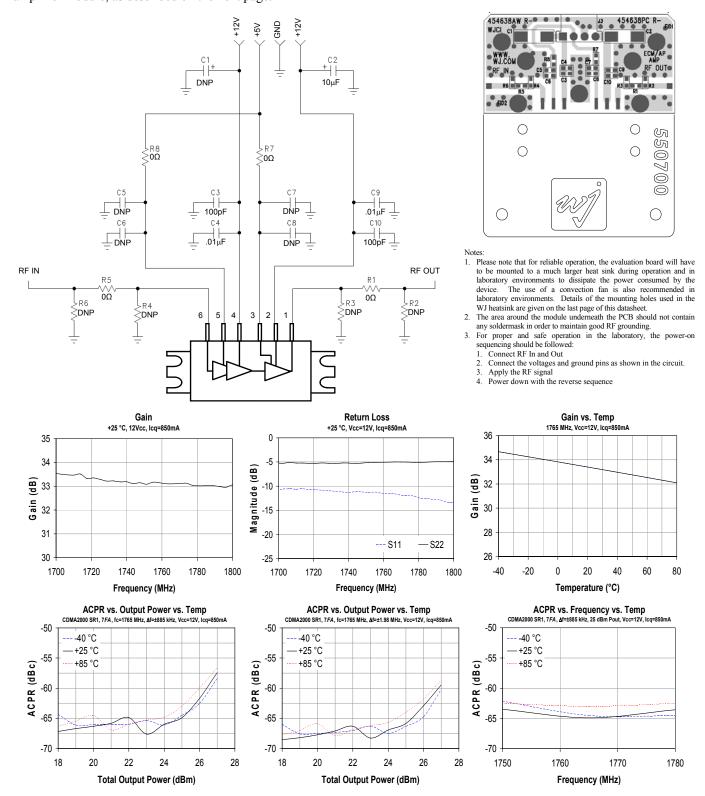
Departion of this device above any of these parameters may cause permanent damage.

^{2.} The current can be adjusted through an external resistor from the 5V supply to the pull-down voltage pin (pin 3).

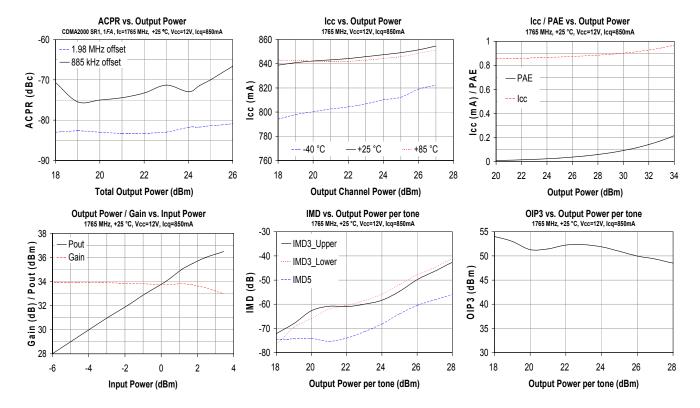


Performance Graphs – Class AB Configuration (AP504-PCB)

The AP504-PCB and AP504 module is configured for Class AB by default. The resistor – R7 – which sets the current draw for the amplifier is set at 0 Ω in this configuration. Increasing that value will decrease the quiescent and operating current of the amplifier module, as described on the next page.



Performance Graphs (cont'd)



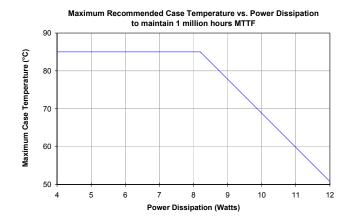
MTTF Calculation

The MTTF of the AP504 can be calculated by first determining how much power is being dissipated by the amplifier module. Because the device's intended application is to be a power amplifier pre-driver or final stage output amplifier, the output RF power of the amplifier will help lower the overall power dissipation. In addition, the amplifier can be biased with different quiescent currents, so the calculation of the MTTF is custom to each application.

The power dissipation of the device can be calculated with the following equation:

$$\begin{split} P_{diss} &= V_{cc} * I_{cc} - (Output \ RF \ Power - Input \ RF \ Power), \\ V_{cc} &= Operating \ supply \ voltage = \textbf{12V} \\ I_{cc} &= Operating \ current \\ &\{ The \ RF \ power \ is \ converted \ to \ Watts \} \end{split}$$

While the maximum recommended case temperature on the datasheet is listed at 85 °C, it is suggested that customers maintain an MTTF above 1 million hours. This would convert to a derating curve for maximum case temperature vs. power dissipation as shown in the plot below.



To calculate the MTTF for the module, the junction temperature needs to be determined. This can be easily calculated with the module's power dissipation, the thermal resistance value, and the case temperature of operation:

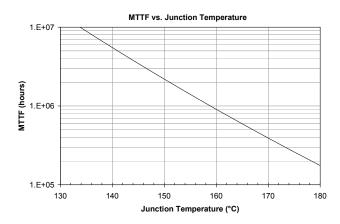
$$\begin{split} T_{j} &= P_{diss} * R_{th} + T_{case} \\ T_{j} &= \text{Junction temperature} \\ P_{diss} &= \text{Power dissipation (calculated from above)} \\ R_{th} &= \text{Thermal resistance} = \textbf{9 °C/W} \\ T_{case} &= \text{Case temperature of module's heat sink} \end{split}$$

From a numerical standpoint, the MTTF can be calculated using the Arrhenius equation:

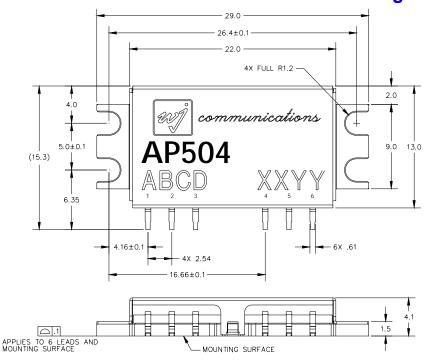
MTTF = A*
$$e^{(Ea/k/T_j)}$$

A = Pre-exponential Factor = **6.087** x **10**⁻¹¹ hours
Ea = Activation Energy = **1.39** eV
k = Boltzmann's Constant = **8.617** x **10**⁻⁵ eV/ °K
 T_i = Junction Temperature (°K) = T_i (°C) + 273

A graphical view of the MTTF can be shown in the plot below.

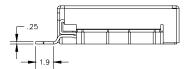


Outline Drawing

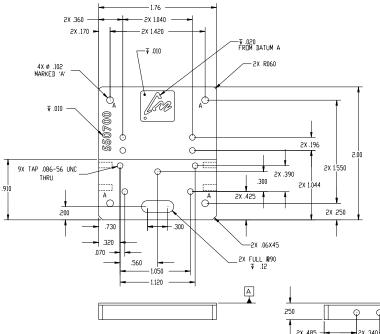


NOTES:

- DIMENSIONING & TOLERANCING CONFORM TO ANSI Y14.4M-1994.
- ALL DIMENSIONS ARE IN MILLIMETERS (INCHES). ANGLES ARE IN DEGREES.
- 3. PIN ASSIGNMENTS:
- [PIN 1] RF OUT
- [PIN 2] +12 Vcc
- [PIN 3] Vpd
- [PIN 4] +12 Vcc
- [PIN 5] Vpd [PIN 6] RF IN
- [CASE] GROUND



Outline Drawing for the Heatsink with the WJ Evaluation Board



Product Marking

The device will be marked with an "AP504" designator with an alphanumeric lot code on the top surface of the package noted as "ABCD" on the drawing. A manufacturing date will also be printed as "XXYY", where the "XX" represents the week number from 1-52.

The product will be shipped in tubes in multiples of 15.

ESD / MSL Information



Caution! ESD sensitive device.

ESD Rating: Class 1C

Value: Passes at ≥ 1,000 to < 2,000 volts
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

ESD Rating: Class III

Value: Passes ≥ 500 to < 1,000 volts
Test: Charged Device Model (CDM)
Standard: JEDEC Standard JESD22-C101

